

/ Descriptions

TO-126F PNP

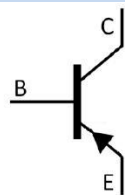
/ Features

3 , ,

/ Applications

$V_{CE(sat)}$, h_{FE} .

/ Equivalent Circuit



/ Pinning



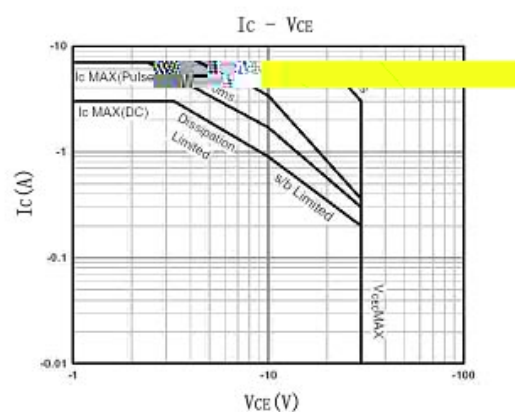
/ h_{FE} Classifications & Marking

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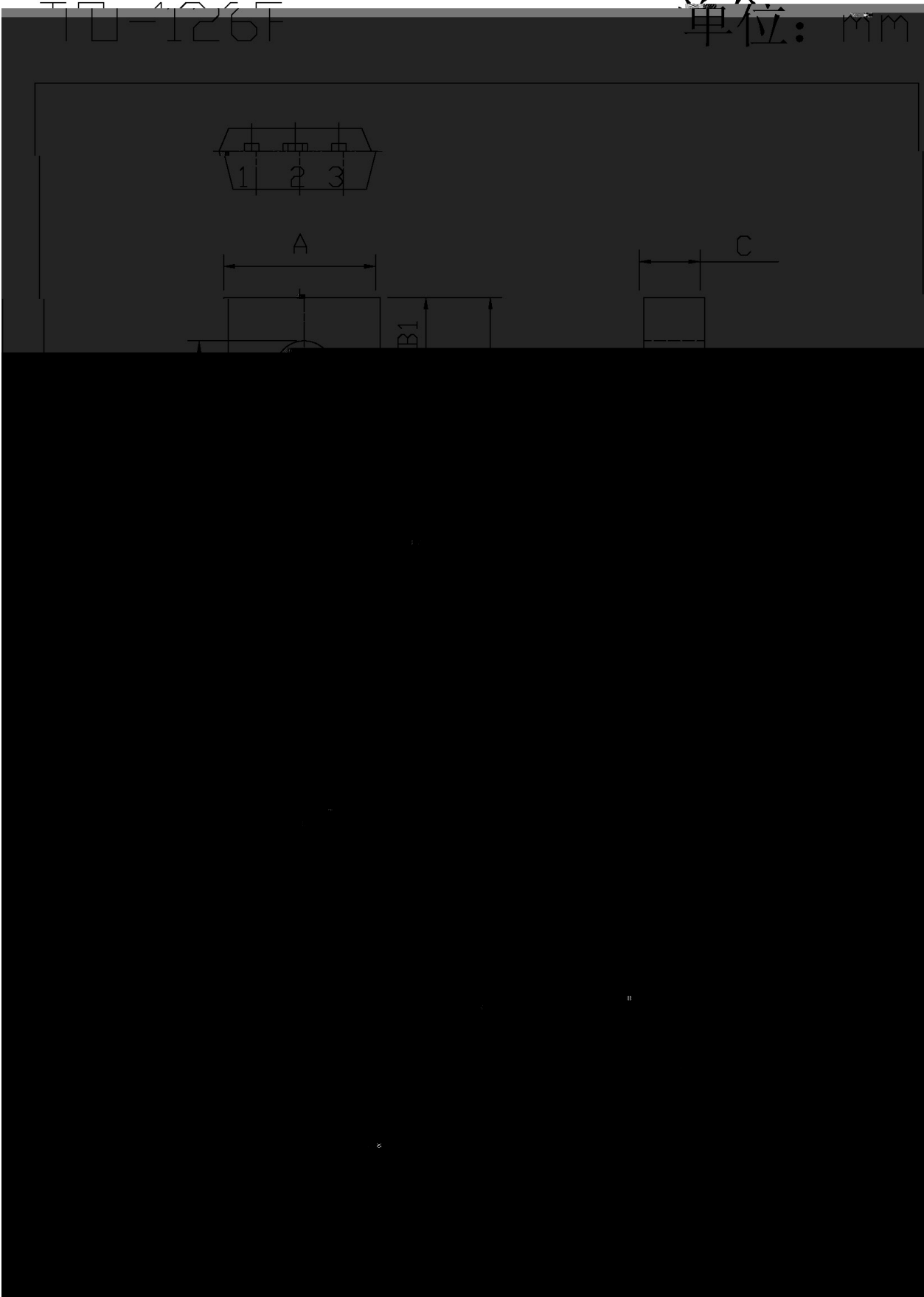
		~	

						μ
						μ

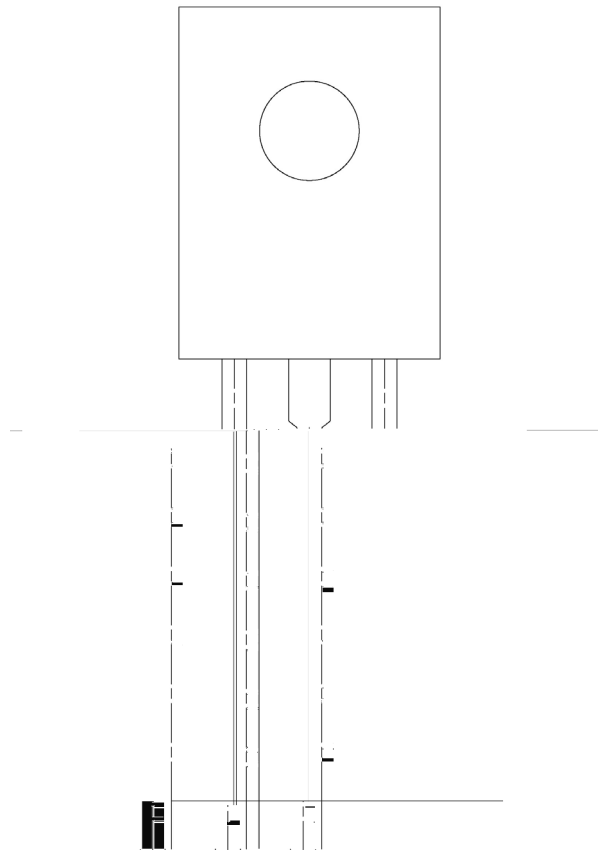
/ Electrical Characteristic Curve



/ Package Dimensions



/ Marking Instructions



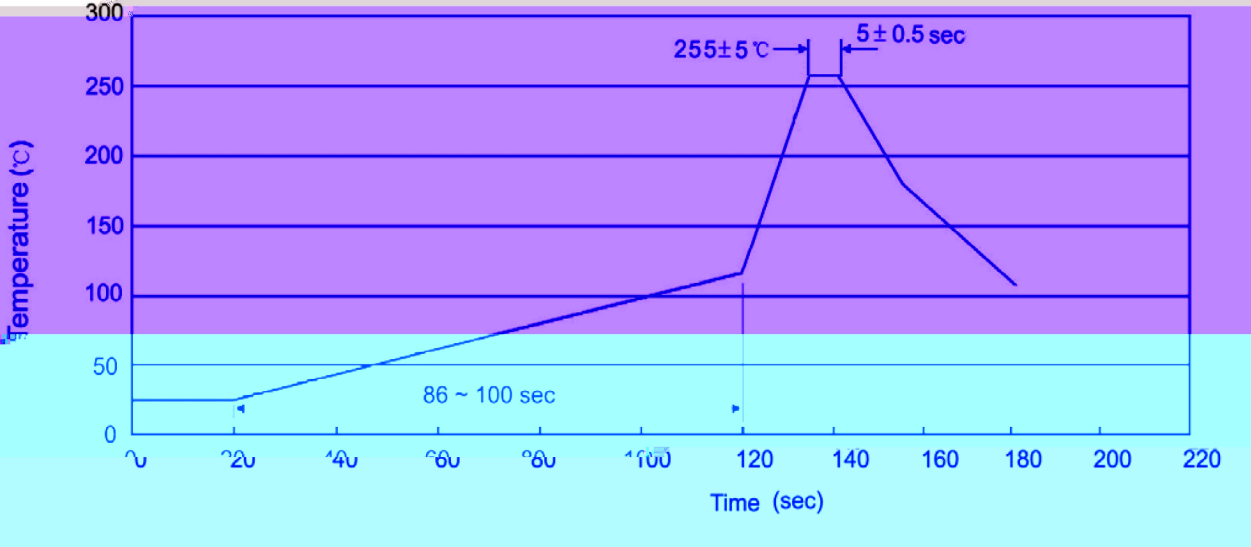
BR

B772

O

h_{FE}

() / Temperature Profile for Dip Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ±

/ Packaging SPEC.

封装形式	包装数量					包装尺寸		
	只 套管	套管 盒	只 盒	盒 箱	只 箱	套管	盒	箱

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